HLPP 2023 Call for Sponsorship

We would like to invite you to be a sponsor for the upcoming 16th International Symposium on High-Level Parallel Programming and Applications (HLPP 2023). The conference will take place from June 29 to June 30, 2023, and will be held at the Babeș-Bolyai University, Cluj-Napoca, Romania (https://www.cs.ubbcluj.ro/hlpp2023/). HLPP is a leading forum for researchers and practitioners in high-level parallel programming and related fields (http://hlpp.net).

As a sponsor of HLPP 2023, your company will have the opportunity to gain visibility and recognition among a highly targeted audience of researchers, educators, and industry professionals. You will also have the chance to showcase your products, services, and expertise to a diverse community of experts in the field.

We offer several sponsorship packages to choose from, each with a unique set of benefits and opportunities. These packages include options for exhibition space, branding opportunities, speaking slots, and more. Our sponsorship team is also happy to work with you to create a customized package that meets your specific needs and objectives.

In addition to the benefits of sponsorship, your company will be supporting an important and growing area of research and development. HLPP is dedicated to advancing the state of the art in parallel programming and applications, and your support will help make this possible.

We hope you will consider becoming a sponsor of HLPP 2023 and look forward to hearing from you soon. Please contact our sponsorship team at hlpp2023@cs.ubbcluj.ro for more information or to discuss sponsorship opportunities.

Thank you for your consideration.

Sincerely,

HLPP 2023 Conference Chairs
Virginia Niculescu
Darius Bufnea
Adrian Sterca